Effect of reflow temperature of tinbismuth finish to thermal cycling test

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Introduction

The tin-bismuth finish have excellent whisker mitigation ability than tin finish. But JEITA reported that tin-bismuth finish on alloy 42 after high temperature reflow generated the long tin whisker under heat cycling test.

In this report, an appropriate reflow temperature was investigated from the relation of the reflow peak temperature and tin whiskers generation.

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Conclusion

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The whiskers generated above 240deg.C that caused tin-bismuth deposits to melt completely. By contrast, the reflow temperature is below 230deg.C generated no whiskers. Therefore tin-bismuth finish could apply to alloy42 when the reflow temperature is below 230deg.C.

This evaluation with the electric component terminal without soldering should be used only as a guide. Because electric component terminals with soldering are formed fillet with much solder.

Table 1 Maximum length of tin whiskers on thermalcycling test

Reflow temperature	Thermal cycling	3	, ,	
(deg.C)	500	1000	1500	2000
210	Not obseved	Not obseved	Not obseved	Not obseved
220	Not obseved	Not obseved	Not obseved	Not obseved
230	Not obseved	Not obseved	Not obseved	Not obseved
240	17.9	21.0	13.2	23.7
250	22.2	21.0	21.1	28.0
260	15.0	34.2	24.2	27.0

Unit:micrometer



Experimental

Experimental condition

Whisker observation method

Thermal cycling test: -45deg.C to +80deg.C (20min./cycle)

Test pieces

- Leadframe: alloy42
- Finish:
 - Tin-2%bismuth plating process :UTB PF-05SH process
- Thickness: 10 µm measured by XRF coating thickness measurement

Plating composition

Tin-2%bismuth prod	amts.	
UTB PF-TIN15	(g/L)	533
UTB PF-BI15	(g/L)	26.7
UTB PF-ACID	(g/L)	125
UTB PF-05SH-A	(ml/L)	30
UTB PF-05SH-B	(ml/L)	10
Sn2+	(g/L)	80
Bi3+	(g/L)	4
Free acid	(g/L)	140

Plating condition

Tin-2%bismuth process

Cathodic current dencity	(A/dm2)	15
bath tempearute	`()	50
Anode material		Tin

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Results

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× 210 - 220 − 230 - 240 - 250

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